



# Product Change Notification

**Change Notification #: 114880 - 00**

**Change Title: Intel® Server System  
R2312WTTYSR,**

**PCN 114880-00,  
Product Design, Product Material,**

**Replacement of components under  
RoHS exemptions and PSOC  
firmware update.**

**Date of Publication: September 07, 2016**

## Key Characteristics of the Change:

Product Design, Product Material

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material: *</b>	Sep 12, 2016
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is implementing the following changes on the product Intel® Server System R2312WTTYSR:

1. Replacement of components containing substances listed under EU RoHS exemption 6(c), 7(c)-1 and 15 with exemption-free versions. Components containing substances listed under EU RoHS exemption 7(a) are not affected with exception of one Integrated Circuit. All new components are identical in form factor and function to the replaced ones.
2. The firmware of the PSOC for Hot-swap Backplanes (HSBPs ) will be updated from version 1.12 to 1.19.

The system software update package, including the release notes for each, is available for download from <http://www.intel.com/support>. Please refer to the software release notes for a list of changes.

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
R2312WTTYSR	943830	J11495-004	G92187-367	J11495-005	G92187-371

## PCN Revision History:

**Date of Revision:**

September 7, 2016

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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